Product Data Sheet

PD-0071-A

3MTM Pak 50 Board-to-Board Connectors, P50 Series Socket and Plug P5X-XXXSX-SX1-XX P5X-XXXSX-RX1-XX P5X-XXXPX-SX1-XX P5X-XXXPX-SX1-XX

Title:

3MTM Pak 50 Board-to-Board Connectors, P50 Series Socket and Plug

Subject: P50 Series

Issue Date: 8-25-2009 Supersedes: Initial Issue

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tle: 3M™ Pak 50 Board-to-Board Connectors, P50 Series Socket and Plug

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1.0 Scope

This data sheet summarizes test methods, test conditions and product performance for the 3M P50 Series Board-to-Board Connectors. The connectors are for Board-to-Board connection with two rows of ribbon style contacts at a 0.050" pitch. Connectors are available in straight, right angle, through hole, and SMT configurations.

2.0 Product Tested

Product:	P50 Socket			
Product Number:	Group A – G1,G3: P50-100S-S1-EA			
	G3: P50-060S-S1-EA			
	G4: P50-060~080S-S1-EA			
	I, II, IV: Contact Only			
	III, V: P50-100S-RR1-EA			
Related Specification Sheet:	TS-2046, TS-2047, TS-2052, TS-2051			
Mating Product:	P50L Plug			
Mating Product Number:	Group A – G1.G3: P50-100P-S1-EA			
-	G3: P50-060P-S1-EA			
	G4: P50-060~080P-S1-EA			
	I, II, IV: Contact Only			
	II, V: P50-100P-RR1-EA			

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3.0 General Conditions

3.1 Test Specimens

The test specimens shall be strictly in compliance with the design, construction details and physical properties detailed in the relevant Technical Specification Sheet or Engineering Drawing.

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4.0 Test Results Summary

Items		Specification	Test Method	Results	
General	Visual and Construction	Conform to the design drawings	Visual Inspection	Pass	
Electrical	Low Level Contact Resistance (LLCR)	Max. R: < 25 mΩ 4 Wire Measurement Current: 100mA DC		Pass	
	Dielectric Withstanding Voltage (DWV)	No dielectric break down or Acing	Apply 650 VAC _{RMS} Voltage for 1 minute between 2 adjacent contacts	Pass	
	Insulation Resistance (IR)	1000MΩ Min	Apply 500V DC for 1 minute between two adjacent contacts	Pass	
	Current Rating: All Contacts in Series	Temperature Rise: 40°C or less Results: 0.5A = 13°C Temp. Rise 0.8A = 23°C Temp Rise 0.9A = 32°C Temp Rise 1.0A = 40°C Temp Rise	Ambient: 22°C	Pass	
	Current Rating: 5 Contacts in Series	Temperature Rise: 40°C or less Results: 1.0A = 8°C Temp. Rise 1.5A = 11°C Temp Rise 1.8A = 29°C Temp Rise 2.0A = 38°C Temp Rise	Ambient: 22°C	Pass	
	Current Rating: 1 Contacts	Temperature Rise: 40°C or less Results: 1.0A = 4°C Temp. Rise 1.5A = 10°C Temp Rise 2.0A = 15°C Temp Rise	Ambient: 22°C	Pass	
Environmenta 1	Humidity (Steady State)	No damage or deformation DWV: No Breakdown or Arcing LLCR: 25 mΩ Max	Humidity: 90~95% RH Temerature: 40°C Duration: 96 hours	Pass	
	Life at Elevated Ambient Temperature (Thermal Aging)	LLCR: 40 mΩ Max No damage or deformation	Temperature: +85°C Duration: 240 hours		
	Thermal Shock	No damage or deformation LLCR: 25 mΩ Max (5 Cycles, -55°C to +85°C)	155°C 30 min 2. +25°C 5 min 3. +85°C 30 min 4. +25°C 5 min Repeat 1 - 4 for 5 Cycles	Pass	
	Salt Spray	No serious corrosion LLCR: 25 mΩ Max	Temperature: 35°C Concentration: 5% Duration: 48 hrs	Pass	
	H ₂ S Exposure	No serious corrosion LLCR: 25 mΩ Max	Temperature: 40°C Concentration: 3 ppm RH: 80% Duration: 48 hrs	Pass	
	SO ₂ Exposure	No serious corrosion LLCR: 25 mΩ Max	Concentration: 10ppm Temperature: 40°C RH: 80% Duration: 48 hrs	Pass	

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Mechanical	Total Insertion Force	Insertion Force: <93.1N (100pins) < 0.931 N per contact	Measure with mating connectors	Pass		
	Withdrawl Forces (Contact Retention Force)	Withdrawl Force: >19.6N(100pins) >19.6N per contact Measure with mating connectors				
	Durability (100 times)	No damage or deformation LLCR: Max. R: $< 25m\Omega$	Ω 400-600 cycles/hour			
	Durability (500 times)	No damage or deformation LLCR: Max. R: $< 25 \text{ m}\Omega$ 500 insertion/withdrawl cycles at 1000 cycles/hour				
	Vibration	No damage or deformation No electrical discontinuity > Amplitude: 1.52 mm Sweep time: 1 min				
			2 hours each in X, Y, and Z directions with 100mA DC applied to all contacts in series	Pass		
	Mechanical Shock	No damage or deformation No electrical discontinuity > 1 μ sec Acceleration: 490m/s² Shock Mode: half sin wave Duration: 11ms 3 Times each in X, Y, and Z and opposite directions with 100mA DC applied to all contacts in series				
	Solderability (Wetting Time)	Zero cross time, 3s Max	1) Precondition: 85°C, 65%RH, 168h 2) Dip into solder bath, 2 mm depth, 20 mm/min. Eutectic: 235°C, Lead Free 245°C	Pass		
	Solderability (Wetted Area)	95% minimum solder coverage	1) Precondition: 85°C, 65%RH, 168h 2) Dip into solder bath, 2 mm depth, 20 mm/min. Eutectic: 235°C, Lead Free 245°C	Pass		
	Solder Heat Resistance	No physical abnormalities after test. LLCR: Max. R: $< 25 \text{ m}\Omega$	J-STD-020C, 260°C	Pass		
	Solder Joint Reliability	Change in pull strength 50% maximum	1) Precondition: 85°C, 65%RH, 168h 2) Reflow solder 3 sec: Eutectic: 235°C, Lead Free 245°C 3) Temperature Cycle -40°C to +125°C, 30 min each extreme, 1000 cycles 4) Apply load at 5 mm/min on initial and after cycling	Pass		
	Whisker Test	No whiskers on Sn surface using 100x magnification				

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Testing

Test methods are based upon common electronics industry test methods.

5.1 **Test Sequence**

Tests conducted according to the sequence outlined in the chart below.

Tests		Sequence Group						
	A	В	С	D	Е	F	G	Others*
Visual and Construction	1	1	1	1	1	1		
Insulation Resistance	2	2						
Dielectric Withstanding Voltage	3	3,7						
Low Level Contact Resistance	4	4,8	3,6	3,5	3,5	3,5		
Total Insertion Force	5							
Total Withdrawl Force	6							
Thermal Shock	7							
Vibration	8							
Shock	9		4					
Humidity		5	5					
Durability (100 times)		6	2	2	2	2		
Salt Spray		7						
SO2 Exposure				4				
H2S Exposure					4			
Life at Elevated Ambient Temperature						4		
Contact Retention Force							1	
Durability (500 Times)							2	
Current Rating							3	
Total Insertion and Withdrawl Force							4	
Solderability (Wetting time)								I
Solderability (Wetting area)								II
Soldering Heat Resistance								III
Solder Joint Reliability								IV
Whisker Test								V

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* Tests run individully

Important Notice

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<u>P50-020P-RR1-EA</u> <u>P50-060P-RR1-EA</u> <u>P50-040P-R1-EA</u> <u>P50-020P-R1-EA</u> <u>P50-080S-R1-EA</u> <u>P50-030P-R1-EA</u> <u>P50-020PG-SR1-EA</u> <u>P50-030P-RR1-EA</u> <u>P50-034P-RR1-EA</u> <u>P50-040PG-S1-EA</u> <u>P50-040PG-SR1-EA</u> <u>P50-068SG-S1-EA</u> <u>P50-080PG-SR1-EA</u>